



January 2000
Revised August 2001

74VCXH16373

Low Voltage 16-Bit Transparent Latch with Bushold

General Description

The VCXH16373 contains sixteen non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear to be transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable (OE) is LOW. When OE is HIGH, the outputs are in a high impedance state.

The VCXH16373 data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating data inputs at a valid logic level.

The 74VCXH16373 is designed for low voltage (1.65V to 3.6V) V_{CC} applications with output compatibility up to 3.6V.

The 74VCXH16373 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

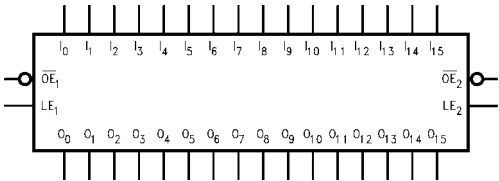
- 1.65V–3.6V V_{CC} supply operation
- 3.6V tolerant control inputs and outputs
- Bushold on data inputs eliminates the need for external pull-up/pull-down resistors
- t_{PD} (I_n to O_n)
 - 3.0 ns max for 3.0V to 3.6V V_{CC}
 - 3.4 ns max for 2.3V to 2.7V V_{CC}
 - 6.8 ns max for 1.65V to 1.95V V_{CC}
- Static Drive (I_{OH}/I_{OL})
 - ± 24 mA @ 3.0V V_{CC}
 - ± 18 mA @ 2.3V V_{CC}
 - ± 6 mA @ 1.65V V_{CC}
- Uses patented noise/EMI reduction circuitry
- Latch-up performance exceeds 300 mA
- ESD performance:
 - Human body model > 2000V
 - Machine model > 200V
- Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

Ordering Code:

Order Number	Package Number	Package Description
74VCXH16373GX (Note 1)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [TAPE and REEL]
74VCXH16373MTD (Note 2)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Note 1: BGA package available in Tape and Reel only.
Note 2: Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol

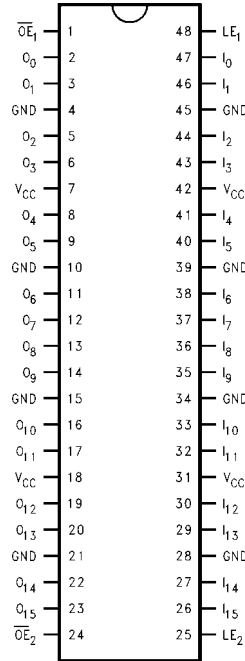


74VCXH16373 Low Voltage 16-Bit Transparent Latch with Bushold

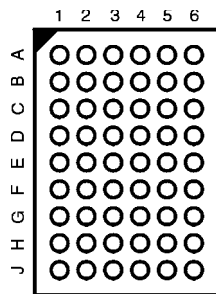
74VCXH16373

Connection Diagrams

Pin Assignment for TSSOP



Pin Assignment for FBGA



(Top Thru View)

Pin Descriptions

Pin Names	Description
$\overline{OE}_n$	Output Enable Input (Active LOW)
LE_n	Latch Enable Input
I_0-I_{15}	Bushold Inputs
O_0-O_{15}	Outputs
NC	No Connect

FBGA Pin Assignments

	1	2	3	4	5	6
A	O_0	NC	$\overline{OE}_1$	LE_1	NC	I_0
B	O_2	O_1	NC	NC	I_1	I_2
C	O_4	O_3	V_{CC}	V_{CC}	I_3	I_4
D	O_6	O_5	GND	GND	I_5	I_6
E	O_8	O_7	GND	GND	I_7	I_8
F	O_{10}	O_9	GND	GND	I_9	I_{10}
G	O_{12}	O_{11}	V_{CC}	V_{CC}	I_{11}	I_{12}
H	O_{14}	O_{13}	NC	NC	I_{13}	I_{14}
J	O_{15}	NC	$\overline{OE}_2$	LE_2	NC	I_{15}

Truth Tables

Inputs			Outputs
LE_1	$\overline{OE}_1$	I_0-I_7	O_0-O_7
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

Inputs			Outputs
LE_2	$\overline{OE}_2$	I_8-I_{15}	O_8-O_{15}
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

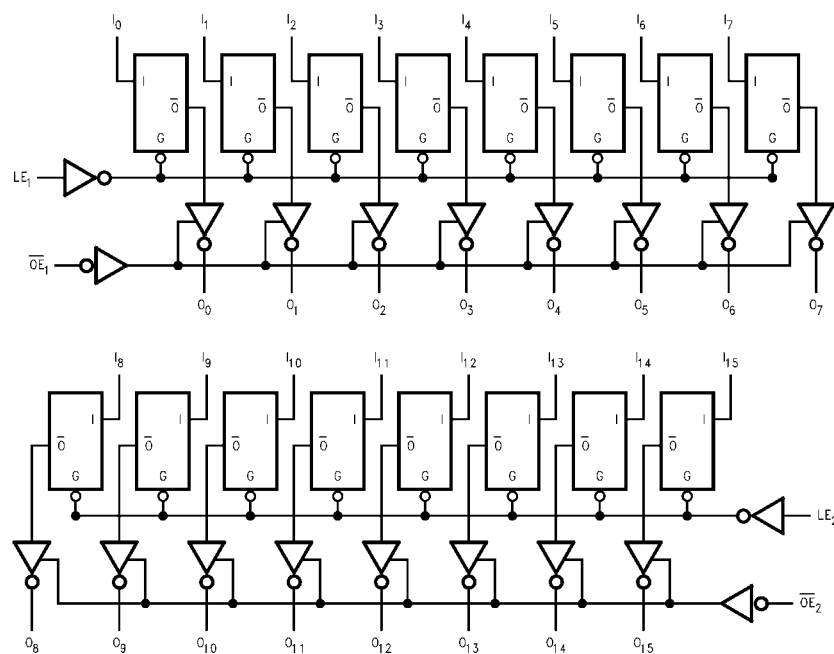
H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial (HIGH or LOW, control inputs may not float)
Z = High Impedance
 O_0 = Previous O_0 before HIGH-to-LOW of Latch Enable

Functional Description

The 74VCXH16373 contains sixteen edge D-type latches with 3-STATE outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the I_n enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time

its I input changes. When LE_n is LOW, the latches store information that was present on the I inputs a setup time preceding the HIGH-to-LOW transition on LE_n . The 3-STATE outputs are controlled by the Output Enable ($\overline{OE}_n$) input. When $\overline{OE}_n$ is LOW the standard outputs are in the 2-state mode. When $\overline{OE}_n$ is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

74VCXH16373

Absolute Maximum Ratings (Note 3)

Supply Voltage (V_{CC})	-0.5V to +4.6V
DC Input Voltage (V_I)	
$\overline{OE}_n, LE_n$	-0.5V to 4.6V
$I_0 - I_{15}$	-0.5V to $V_{CC} + 0.5V$
Output Voltage (V_O)	
Outputs 3-STATED	-0.5V to +4.6V
Outputs Active (Note 4)	-0.5V to $V_{CC} + 0.5V$
DC Input Diode Current (I_{IK})	
$V_I < 0V$	-50 mA
DC Output Diode Current (I_{OK})	
$V_O < 0V$	-50 mA
$V_O > V_{CC}$	+50 mA
DC Output Source/Sink Current (I_{OH}/I_{OL})	± 50 mA
DC V_{CC} or GND Current per Supply Pin (I_{CC} or GND)	± 100 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C

Recommended Operating Conditions (Note 5)

Power Supply	
Operating	1.65V to 3.6V
Data Retention Only	1.2V to 3.6V
Input Voltage	-0.3V to V_{CC}
Output Voltage (V_O)	
Output in Active States	0V to V_{CC}
Output in "OFF" State	0.0V to 3.6V
Output Current in I_{OH}/I_{OL}	
$V_{CC} = 3.0V$ to 3.6V	± 24 mA
$V_{CC} = 2.3V$ to 2.7V	± 18 mA
$V_{CC} = 1.65V$ to 2.3V	± 6 mA
Free Air Operating Temperature (T_A)	-40°C to +85°C
Minimum Input Edge Rate ($\Delta t/\Delta V$)	
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10 ns/V

Note 3: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 4: I_O Absolute Maximum Rating must be observed.

Note 5: Floating or unused inputs must be held HIGH or LOW.

DC Electrical Characteristics (2.7V < $V_{CC} \leq 3.6V$)

Symbol	Parameter		Conditions	V_{CC} (V)	Min	Max	Units
V_{IH}	HIGH Level Input Voltage			2.7-3.6	2.0		V
V_{IL}	LOW Level Input Voltage			2.7-3.6		0.8	V
V_{OH}	HIGH Level Output Voltage		$I_{OH} = -100 \mu A$	2.7-3.6	$V_{CC} - 0.2$		V
			$I_{OH} = -12 \text{ mA}$	2.7	2.2		V
			$I_{OH} = -18 \text{ mA}$	3.0	2.4		V
			$I_{OH} = -24 \text{ mA}$	3.0	2.2		V
V_{OL}	LOW Level Output Voltage		$I_{OL} = 100 \mu A$	2.7-3.6		0.2	V
			$I_{OL} = 12 \text{ mA}$	2.7		0.4	V
			$I_{OL} = 18 \text{ mA}$	3.0		0.4	V
			$I_{OL} = 24 \text{ mA}$	3.0		0.55	V
I_I	Input Leakage Current	Control Pins	$0 \leq V_I \leq 3.6V$	2.7-3.6		± 5.0	μA
		Data Pins	$V_I = V_{CC}$ or GND	2.7-3.6		± 5.0	μA
$I_{I(HOLD)}$	Bushold Input Minimum Drive Hold Current		$V_{IN} = 0.8V$	3.0	75		μA
			$V_{IN} = 2.0V$	3.0	-75		μA
$I_{I(OD)}$	Bushold Input Over-Drive Current to Change State		(Note 6)	3.6	450		μA
			(Note 7)	3.6	-450		μA
I_{OZ}	3-STATE Output Leakage		$0 \leq V_O \leq 3.6V$ $V_I = V_{IH}$ or V_{IL}	2.7-3.6		± 10	μA
I_{OFF}	Power-OFF Leakage Current		$0 \leq (V_O) \leq 3.6V$	0		10	μA
I_{CC}	Quiescent Supply Current		$V_I = V_{CC}$ or GND	2.7-3.6		20	μA
			$V_{CC} \leq (V_O) \leq 3.6V$ (Note 8)	2.7-3.6		± 20	μA
ΔI_{CC}	Increase in I_{CC} per Input		$V_{IH} = V_{CC} - 0.6V$	2.7-3.6		750	μA

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 8: Outputs disabled or 3-STATE only.

DC Electrical Characteristics (2.3V ≤ V _{CC} ≤ 2.7V)							
Symbol	Parameter		Conditions	V _{CC} (V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage			2.3 – 2.7	1.6		V
V _{IL}	LOW Level Input Voltage			2.3 – 2.7		0.7	V
V _{OH}	HIGH Level Output Voltage		I _{OH} = –100 μA	2.3 – 2.7	V _{CC} – 0.2		V
			I _{OH} = –6 mA	2.3	2.0		V
			I _{OH} = –12 mA	2.3	1.8		V
			I _{OH} = –18 mA	2.3	1.7		V
V _{OL}	LOW Level Output Voltage		I _{OL} = 100 μA	2.3 – 2.7		0.2	V
			I _{OL} = 12 mA	2.3		0.4	V
			I _{OL} = 18 mA	2.3		0.6	V
I _I	Input Leakage Current	Control Pins	0 ≤ V _I ≤ 3.6V	2.3 – 2.7		±5.0	μA
		Data Pins	V _I = V _{CC} or GND	2.3 – 2.7		±5.0	μA
I _{I(HOLD)}	Bushold Input Minimum Drive Hold Current		V _{IN} = 0.7V	2.3	45		μA
			V _{IN} = 1.6V	2.3	–45		
I _{I(OD)}	Bushold Input Over-Drive Current to Change State		(Note 9)	2.7	300		μA
			(Note 10)	2.7	–300		
I _{OZ}	3-STATE Output Leakage		0 ≤ V _O ≤ 3.6V	2.3 – 2.7		±10	μA
			V _I = V _{IH} or V _{IL}				
I _{OFF}	Power-OFF Leakage Current		0 ≤ (V _O) ≤ 3.6V	0		10	μA
I _{CC}	Quiescent Supply Current		V _I = V _{CC} or GND	2.3 – 2.7		20	μA
			V _{CC} ≤ (V _O) ≤ 3.6V (Note 11)	2.3 – 2.7		±20	μA
Note 9: An external driver must source at least the specified current to switch from LOW-to-HIGH.							
Note 10: An external driver must sink at least the specified current to switch from HIGH-to-LOW.							
Note 11: Outputs disabled or 3-STATE only.							

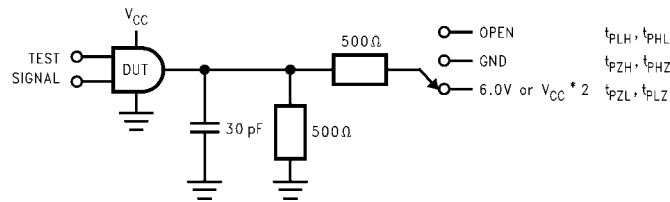
DC Electrical Characteristics (1.65V ≤ V_{CC} < 2.3V)

Symbol	Parameter		Conditions	V _{CC} (V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage			1.65 - 2.3	0.65 × V _{CC}		V
V _{IL}	LOW Level Input Voltage			1.65 - 2.3		0.35 × V _{CC}	V
V _{OH}	HIGH Level Output Voltage		I _{OH} = –100 μA	1.65 - 2.3	V _{CC} – 0.2		V
			I _{OH} = –6 mA	1.65	1.25		V
V _{OL}	LOW Level Output Voltage		I _{OL} = 100 μA	1.65 - 2.3		0.2	V
			I _{OL} = 6 mA	1.65		0.3	V
I _I	Input Leakage Current	Control Pins	0 ≤ V _I ≤ 3.6V	1.65 – 2.3		±5.0	μA
		Data Pins	V _I = V _{CC} or GND	1.65 – 2.3		±5.0	μA
I _{I(HOLD)}	Bushold Input Minimum Drive Hold Current		V _{IN} = 0.57V	1.65	25		μA
			V _{IN} = 1.07V	1.65	–25		
I _{I(OD)}	Bushold Input Over-Drive Current to Change State		(Note 12)	1.95	200		μA
			(Note 13)	1.95	–200		
I _{OZ}	3-STATE Output Leakage		0 ≤ V _O ≤ 3.6V	1.65 - 2.3		±10	μA
			V _I = V _{IH} or V _{IL}				
I _{OFF}	Power-OFF Leakage Current		0 ≤ (V _O) ≤ 3.6V	0		10	μA
I _{CC}	Quiescent Supply Current		V _I = V _{CC} or GND	1.65 - 2.3		20	μA
			V _{CC} ≤ (V _O) ≤ 3.6V (Note 14)	1.65 – 2.3		±20	μA
Note 12: An external driver must source at least the specified current to switch from LOW-to-HIGH.							
Note 13: An external driver must sink at least the specified current to switch from HIGH-to-LOW.							
Note 14: Outputs disabled or 3-STATE only.							

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AC Electrical Characteristics (Note 15)								
Symbol	Parameter	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, C_L = 30\text{ pF}, R_L = 500\Omega$						Units
		$V_{CC} = 3.3V \pm 0.3V$		$V_{CC} = 2.5V \pm 0.2V$		$V_{CC} = 1.8V \pm 0.15V$		
		Min	Max	Min	Max	Min	Max	
t_{PHL}, t_{PLH}	Propagation Delay I_n to O_n	0.8	3.0	1.0	3.4	1.5	6.8	ns
t_{PHL}, t_{PLH}	Propagation Delay LE to O_n	0.8	3.0	1.0	3.9	1.5	7.8	ns
t_{PZL}, t_{PZH}	Output Enable Time	0.8	3.5	1.0	4.6	1.5	9.2	ns
t_{PLZ}, t_{PHZ}	Output Disable Time	0.8	3.5	1.0	3.8	1.5	6.8	ns
t_S	Setup Time	1.5		1.5		2.5		ns
t_H	Hold Time	1.0		1.0		1.0		ns
t_W	Pulse Width	1.5		1.5		4.0		ns
t_{OSHL} t_{OSLH}	Output to Output Skew (Note 16)		0.5		0.5		0.75	ns
Note 15: For $C_L = 50\text{pF}$, add approximately 300 ps to the AC maximum specification.								
Note 16: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).								
Dynamic Switching Characteristics								
Symbol	Parameter	Conditions	V_{CC} (V)	$T_A = +25^{\circ}\text{C}$	Units			
				Typical				
V_{OLP}	Quiet Output Dynamic Peak V_{OL}	$C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8 2.5 3.3	0.25 0.6 0.8	V			
V_{OLV}	Quiet Output Dynamic Valley V_{OL}	$C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8 2.5 3.3	-0.25 -0.6 -0.8	V			
V_{OHV}	Quiet Output Dynamic Valley V_{OH}	$C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8 2.5 3.3	1.5 1.9 2.2	V			
Capacitance								
Symbol	Parameter	Conditions	$T_A = +25^{\circ}\text{C}$	Units				
			Typical					
C_{IN}	Input Capacitance	$V_{CC} = 1.8V, 2.5V \text{ or } 3.3V, V_I = 0V \text{ or } V_{CC}$	6	pF				
C_{OUT}	Output Capacitance	$V_I = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	7	pF				
C_{PD}	Power Dissipation Capacitance	$V_I = 0V \text{ or } V_{CC}, f = 10\text{ MHz}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	20	pF				

AC Loading and Waveforms



TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	6V at $V_{CC} = 3.3 \pm 0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2V, 1.8V \pm 0.15V$
t_{PZH}, t_{PHZ}	GND

FIGURE 1. AC Test Circuit

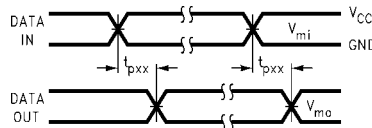


FIGURE 2. Waveform for Inverting and Non-Inverting Functions

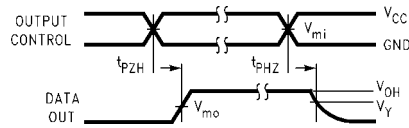


FIGURE 3. 3-STATE Output HIGH Enable and Disable Times for Low Voltage Logic

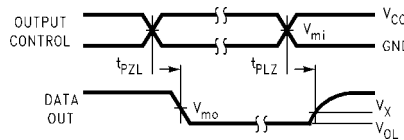


FIGURE 4. 3-STATE Output LOW Enable and Disable Times for Low Voltage Logic

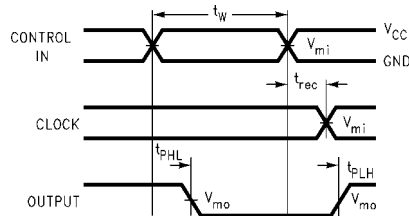


FIGURE 5. Propagation Delay, Pulse Width and t_{REC} Waveforms

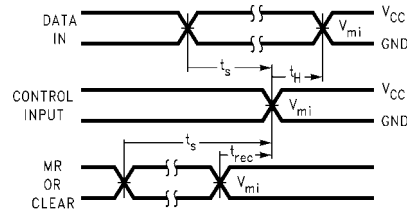
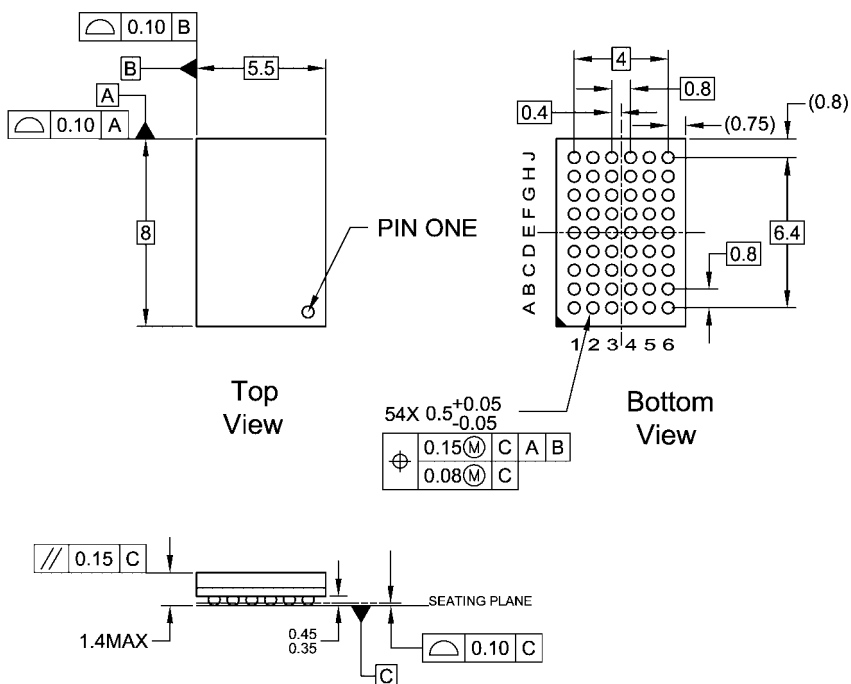


FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic

Symbol	V_{CC}		
	$3.3V \pm 0.3V$	$2.5V \pm 0.2V$	$1.8V \pm 0.15V$
V_{mi}	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_{mo}	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_X	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
V_Y	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$

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Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- THIS PACKAGE CONFORMS TO JEDEC MO-205
- ALL DIMENSIONS IN MILLIMETERS
- LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
.35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
- DRAWING CONFORMS TO ASME Y14.5M-1994

BGA54ArevD

54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
Package Number BGA54A
(Preliminary)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

